

N-channel 40 V, 3.5 mΩ standard level MOSFET in LFPAK56 14 September 2017 Product data sheet

1. General description

Automotive qualified N-channel MOSFET using the latest Trench 9 low ohmic superjunction technology, housed in a robust LFPAK56 package. This product has been fully designed and qualified to meet AEC-Q101 requirements delivering high performance and endurance.

2. Features and benefits

- Fully automotive qualified to AEC-Q101:
 - 175 °C rating suitable for thermally demanding environments
- Trench 9 Superjunction technology:
 - Reduced cell pitch enables enhanced power density and efficiency with lower R_{DSon} in same footprint
 - Improved SOA and avalanche capability compared to standard TrenchMOS
 - Tight V_{GS(th)} limits enable easy paralleling of MOSFETs
- LFPAK Gull Wing leads:
 - High Board Level Reliability absorbing mechanical stress during thermal cycling, unlike traditional QFN packages
 - Visual (AOI) soldering inspection, no need for expensive x-ray equipment
 - Easy solder wetting for good mechanical solder joint
- LFPAK copper clip technology:
 - Improved reliability, with reduced R_{th} and R_{DSon}
 - · Increases maximum current capability and improved current spreading

3. Applications

- 12 V automotive systems
- Motors, lamps and solenoid control
- Start-Stop micro-hybrid applications
- Transmission control
- Ultra high performance power switching

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4. Quick reference data

Table 1. Quick	reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	40	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	-	120	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	115	W
Static charact	eristics						
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 11		2	2.9	3.5	mΩ
Dynamic char	acteristics	·					
Q _{GD}	gate-drain charge	I_D = 25 A; V_{DS} = 32 V; V_{GS} = 10 V; Fig. 13; Fig. 14		-	6	15	nC
Source-drain	diode	·					
Q _r	recovered charge	I_{S} = 25 A; dI _S /dt = -100 A/µs; V _{GS} = 0 V; V _{DS} = 20 V; <u>Fig. 17</u>		-	16	-	nC
S	softness factor	$ I_{S} = 25 \text{ A}; \text{ d}_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 \text{ °C} $		-	0.8	-	

[1] 120A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

5. Pinning information

Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	S	source	mb	D			
2	S	source	ل ا دے ب ا				
3	S	source	q	G			
4	G	gate		mbb076 S			
mb	D	mounting base; connected to drain	1 2 3 4 LFPAK56; Power- SO8 (SOT669)				

6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
BUK7Y3R5-40H	LFPAK56; Power-SO8	plastic, single-ended surface-mounted package; 4 terminals; 4.9 mm x 4.45 mm x 1 mm body	SOT669				

7. Marking

Table 4. Marking codes	
Type number	Marking code
BUK7Y3R5-40H	73H540

8. Limiting values

Table 5. Limiting values

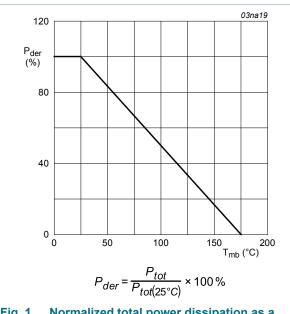
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	40	V
V _{GS}	gate-source voltage	DC; T _j ≤ 175 °C		-10	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	115	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	120	А
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>	[1]	-	93	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; Fig. 3		-	526	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-drain	diode					
I _S	source current	T _{mb} = 25 °C	[1]	-	120	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	526	А
Avalanche ru	uggedness					
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$\label{eq:loss} \begin{array}{l} I_D = 120 \text{ A}; \text{V}_{sup} \leq 40 \text{ V}; \text{R}_{GS} = 50 \Omega; \\ \text{V}_{GS} = 10 \text{ V}; \text{T}_{j(\text{init})} = 25 ^\circ\text{C}; \text{ unclamped}; \\ \hline \text{Fig. 4} \end{array}$	[2] [3]	-	45	mJ

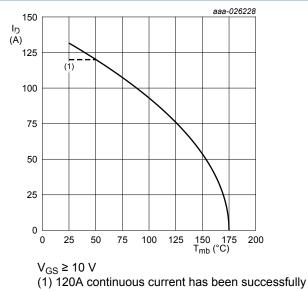
[1] 120A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

[2] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

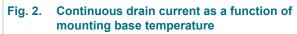
[3] Refer to application note AN10273 for further information.



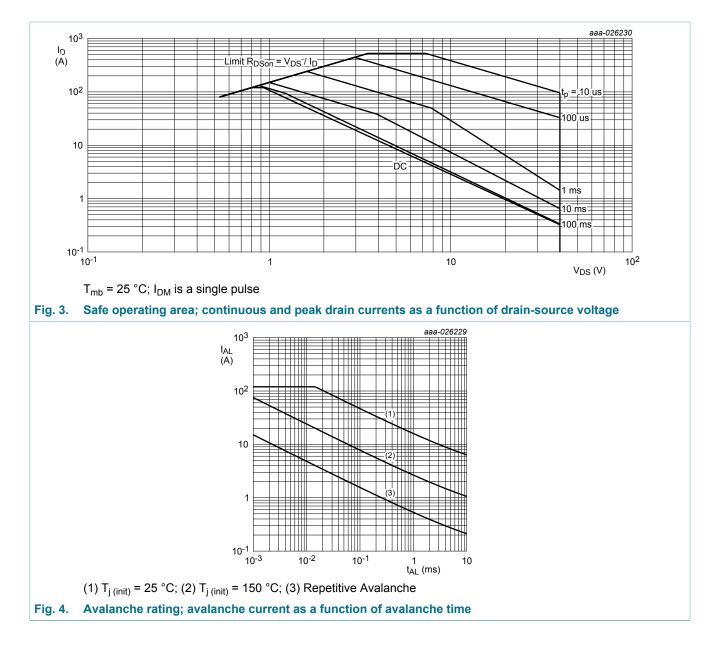




(1) 120A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.



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9. Thermal characteristics

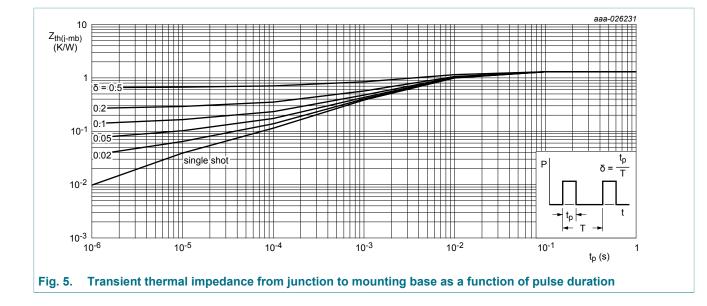
Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 5</u>		-	1.18	1.3	K/W

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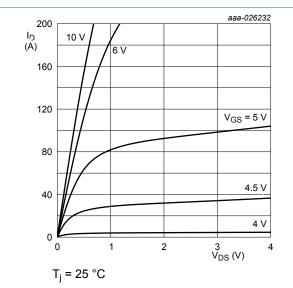
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	octeristics					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	40	42.7	-	V
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = -40 °C	-	40.1	-	V
		I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	36	39.7	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 25 °C; <u>Fig. 9</u> ; <u>Fig. 10</u>	2.4	3	4	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; <u>Fig. 9</u>	-	-	4.5	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; <u>Fig. 9</u>	1	-	-	V
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	0.03	1	μA
		V _{DS} = 16 V; V _{GS} = 0 V; T _j = 125 °C	-	1	10	μA
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C	-	37	500	μA
I _{GSS} gate leakage current	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
	V _{GS} = -10 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA	
R _{DSon} drain-source on-state resistance		V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 11	2	2.9	3.5	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 105 °C; Fig. 12	2.7	4.1	5.2	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 125 °C; Fig. 12	2.9	4.5	5.6	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; Fig. 12	3.4	5.4	6.7	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	0.32	0.8	2	Ω
Dynamic ch	aracteristics	· · ·				
Q _{G(tot)}	total gate charge	I_D = 25 A; V_{DS} = 32 V; V_{GS} = 10 V;	-	31	53	nC
Q _{GS}	gate-source charge	Fig. 13; Fig. 14	-	10	15	nC
Q _{GD}	gate-drain charge		-	6	15	nC
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz;	-	2294	3441	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 15</u>	-	682	954	pF
C _{rss}	reverse transfer capacitance		-	112	247	pF
t _{d(on)}	turn-on delay time	V _{DS} = 30 V; R _L = 1.2 Ω; V _{GS} = 10 V;	-	10	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega$	-	8	-	ns
t _{d(off)}	turn-off delay time	1 1	-	19	-	ns
t _f	fall time	1	-	9	-	ns
Source-drai	n diode		I		1	
V _{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; <u>Fig. 16</u>	-	0.8	1.2	V

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{rr}	reverse recovery time	$I_{S} = 25 \text{ A}; \text{ d}_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 20 \text{ V}; \text{ Fig. 17}$	-	25	-	ns
Qr	recovered charge		-	16	-	nC
S	softness factor	$ I_{\rm S} = 25 \; {\rm A}; \; {\rm dI}_{\rm S}/{\rm dt} = -100 \; {\rm A}/\mu {\rm s}; \; {\rm V}_{\rm GS} = 0 \; {\rm V}; \\ {\rm V}_{\rm DS} = 20 \; {\rm V}; \; {\rm T}_{\rm j} = 25 \; {\rm ^{\circ}C} $	-	0.8	-	
		$ I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -500 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ V_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 17} $	-	0.6	-	



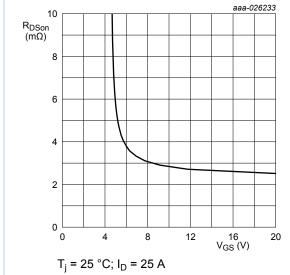


Fig. 6. Output characteristics; drain current as a function of drain-source voltage; typical values

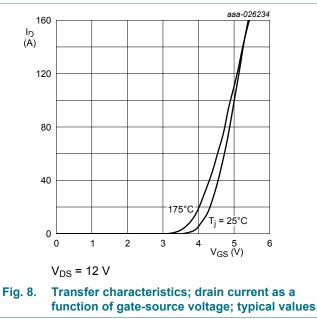
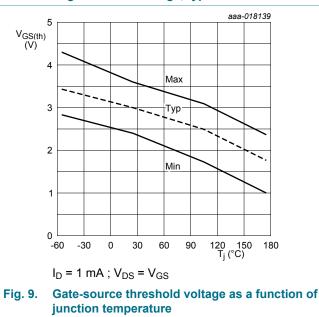
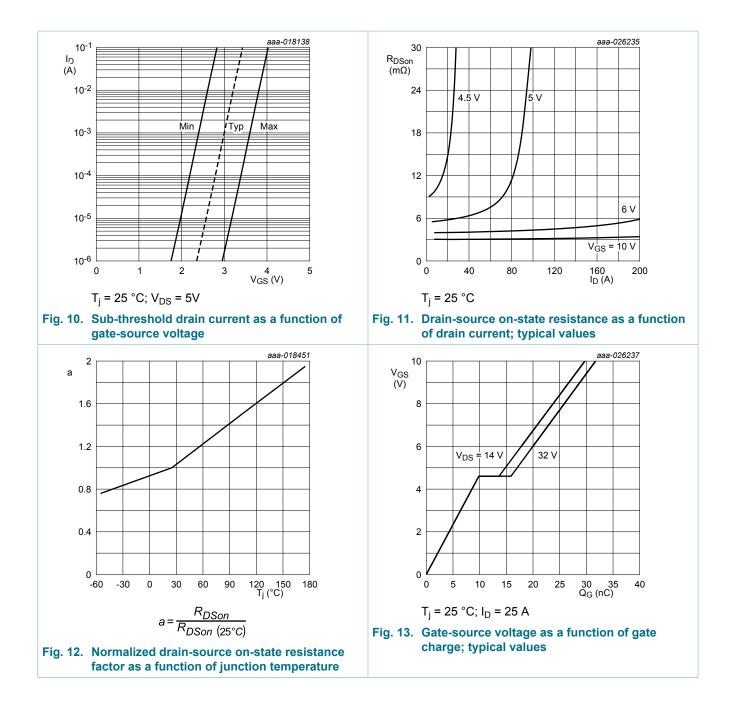


Fig. 7. Drain-source on-state resistance as a function of gate-source voltage; typical values

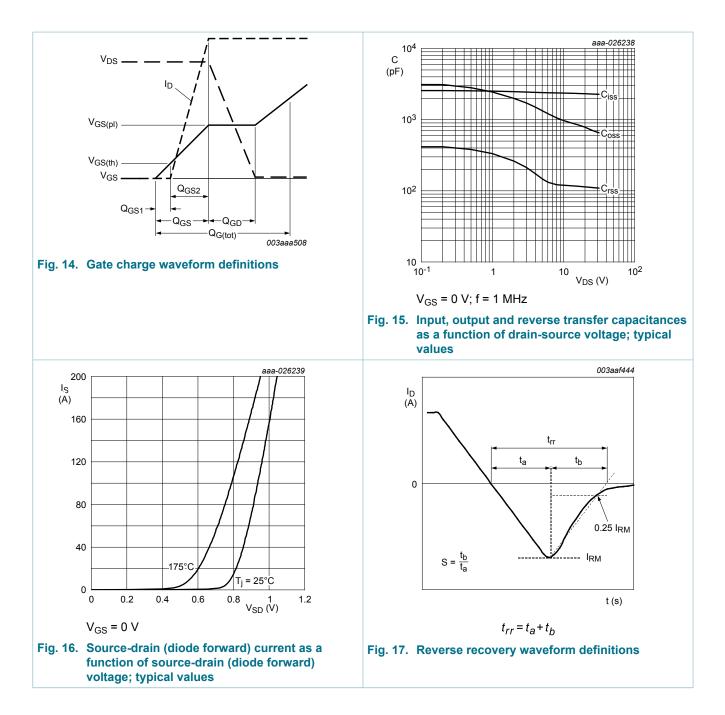


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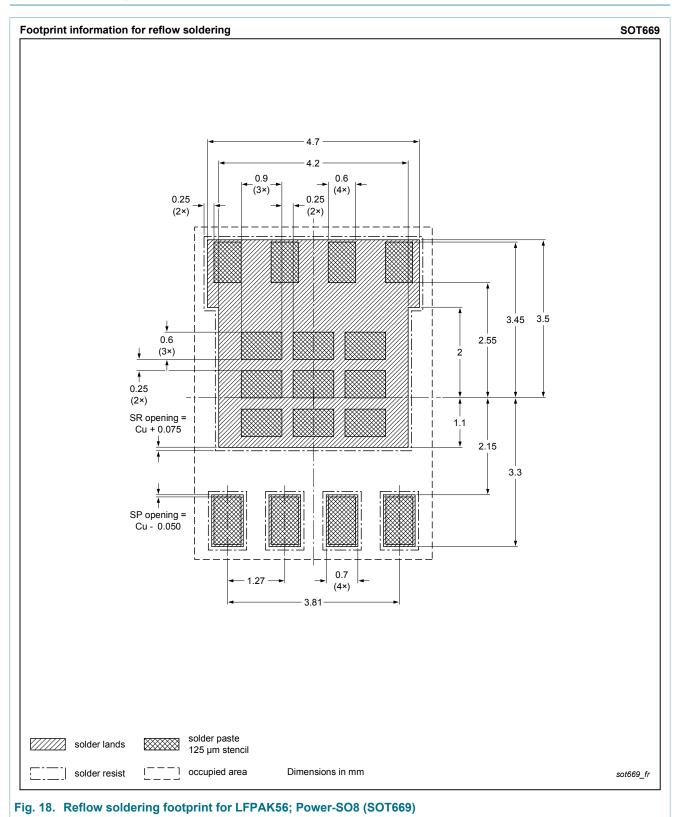
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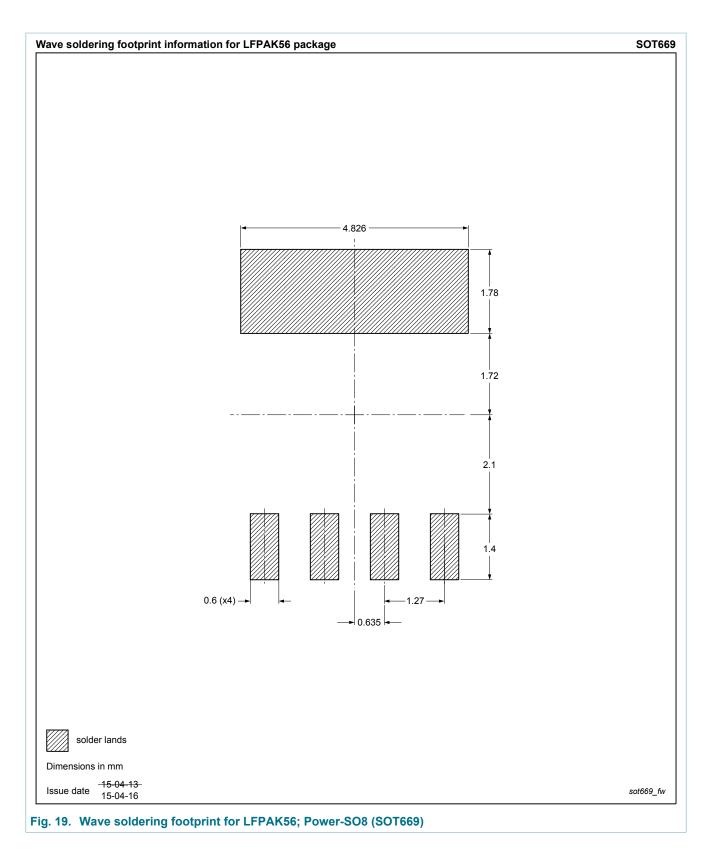


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11. Soldering



BUK7Y3R5-40H



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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